

Features

Frequency range : 4MHz to 125MHz
 Compact and thin
 SMD seam sealing ceramic package
 Supply voltage : 1.8V ~ 3.3V
 CMOS output
 Tri-state function available
 External dimensions (mm)
 L : 2.5 x W : 2.0 x H : 0.8
 RoHS compliant & Pb free

Applications

Mobile phone, Wearables
 Networking, Server, Storage
 Wireless communications
 Fibre channel, Ethernet, SATA, SAS,
 PCI-E, USB, WLAN, BT
 Notebook, HDD, SSD, Graphics card,
 Computer peripherals
 Audio, Video, Gaming, DSC, IP CAM,
 Portable consumer products

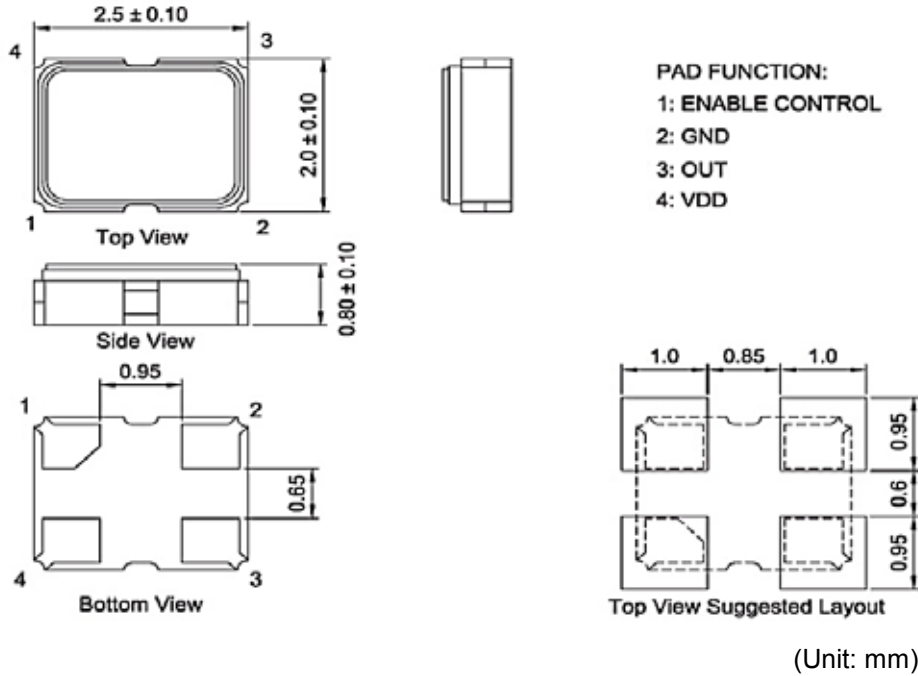
Electrical Characteristics

Item	8W	Conditions
Frequency Range (F_0)	4MHz ~ 125MHz	
Frequency Stability (F_{stab})	$\pm 50\text{ppm}$, $\pm 25\text{ppm}$	Note [1]
Operating Temperature Range (T_{OTR})	$-40^\circ\text{C} \sim +85^\circ\text{C}$	
Supply Voltage (V_{DD})	1.8V, 2.5V, 3.3V	$V_{DD} \pm 10\%$
Current Consumption (I_{DD})	10 mA Max.	
Output Type	CMOS	
Output Load (C_L)	15 pF	
Output Voltage High (V_{OH})	90% V_{DD} Min.	
Output Voltage Low (V_{OL})	10% V_{DD} Max.	
Rise & Fall Time (T_r / T_f)	5 ns Max.	10% ~ 90% of V_{DD}
Duty Cycle	45% ~ 55%	
Start-up Time	5 ms Max.	
Enable Voltage High, Logic "1"	70% V_{DD} Min.	Input to Pin1 Note [2]
Enable Voltage Low, Logic "0"	30% V_{DD} Max.	
Phase Jitter, RMS	1 ps Max.	Note [3]
Aging (F_{aging})	± 3 ppm Max.	at $25^\circ\text{C} \pm 3^\circ\text{C}$, first year
Storage Temperature Range (T_{STR})	$-55^\circ\text{C} \sim +125^\circ\text{C}$	

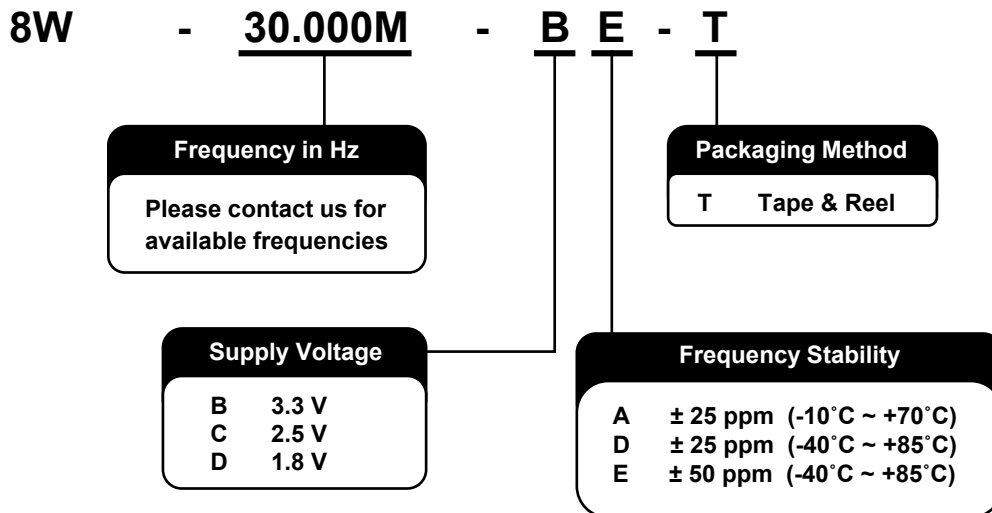
Notes:

- [1] Inclusive of frequency tolerance at 25°C , 1st year aging at 25°C , and variations over operating temperature, supply voltage, and load.
- [2] Output will be enable if Pin1 is Logic "1" or Open; Output will be disable if Pin1 is Logic "0".
- [3] Freq. 10MHz~40MHz, integrated 12kHz~5MHz; Freq. >40MHz, integrated 12kHz~20MHz.

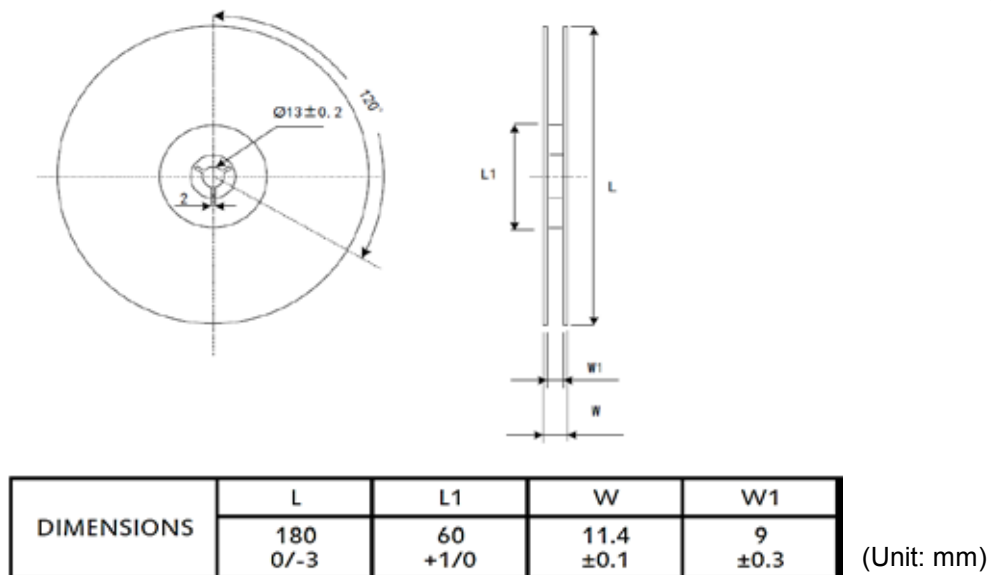
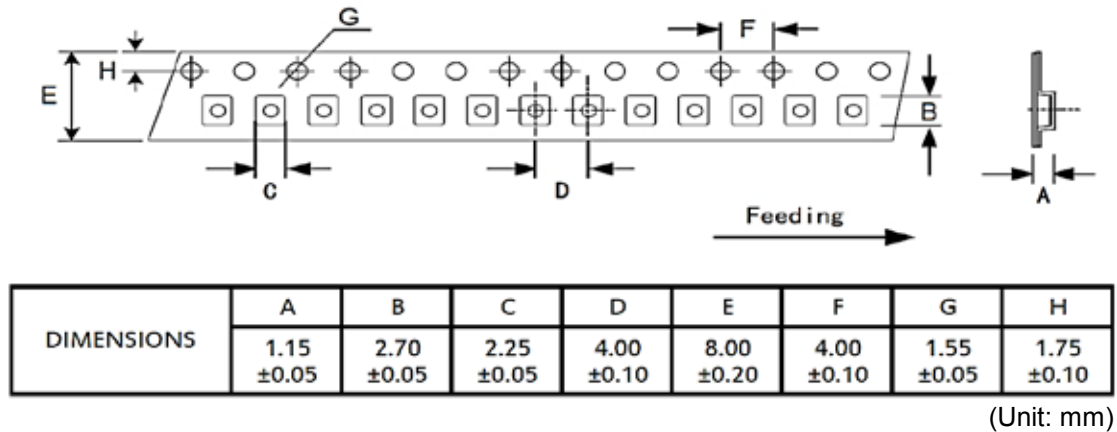
Dimensions



Ordering Information



Packing



Reflow Profile

Solder melting point : 220°C ± 10°C, 60 sec. Min.

Peak temperature : 260°C ± 10°C, 10 sec. Min.

